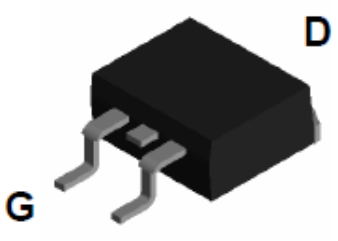
SKD448S

80V N-Channel MOSFET

■ FEATURES

- 80V/80A
  RDS(ON)= 9m**Ω (Max)**@ VGS=10V
- Lead free and Green Device Available
- Low Rds-on to Minimize Conductive Loss
- High avalanche Current

■ PIN DESCRIPTION

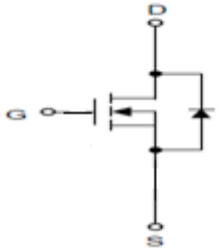


TO-263

RoHS

■ Application

- Power Supply
- DC-DC Converters



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter		Maximum	Unit
V_{DSS}	Drain-to-Source Voltage		80	V
V_{GSS}	Gate-to-Source Voltage		±25	V
I_D[3]	Continuous Drain Current	T_C=25°C	80	A
		T_C=100°C	70	
I_{DP}[4]	Pulsed Drain Current	T_C=25°C	340	
IAS[5]	Avalanche Current		25	
EAS[5]	Avalanche energy		350	mJ
PD	Maximum Power Dissipation	T_C=25°C	240	W
		T_C=100°C	100	
T_J, T_{STG}	Junction & Storage Temperature Range		-55~175	°C

Thermal Characteristics

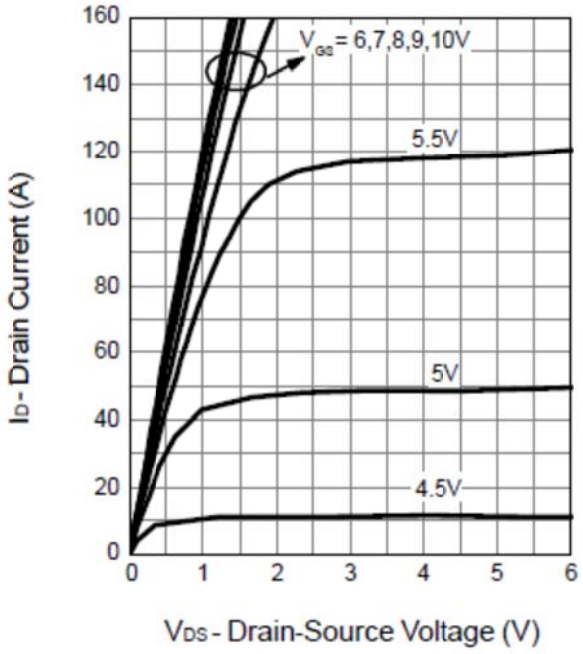
Symbol	Parameter	Typical	Unit
Rθjc	Thermal Resistance-Junction to Case	0.52	°C/W
Rθja	Thermal Resistance-Junction to Ambient	55	

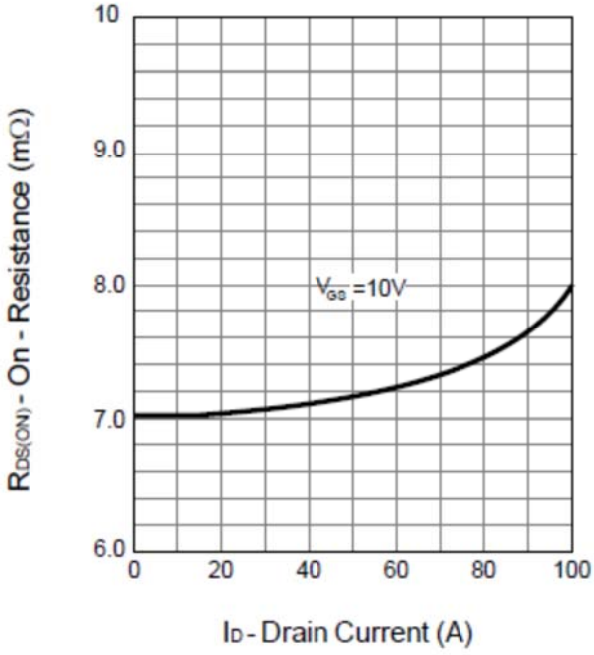
Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ	Max.	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V,I_D=250uA	80	—	—	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=64V,V_{GS}=0V	—	—	1	uA
		T_J=125°C	—	—	100	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250uA	2	3	4	V
I_{GSS}	Gate Leakage Current	V_{GS}=±25V, V_{DS}=0V	—	—	±100	nA
$R_{DS(on)}$[1]	Drain-Source On-Resistance	V_{GS}=10V, I_D=40A	—	7	9	mΩ
			—	—	—	
Diode Characteristics						
V_{SD}[1]	Diode Forward Voltage	I_{SD}=40A,V_{GS}=0V	—	—	1.3	V
I_S[3]	Diode Continuous Forward Current		—	—	80	A
t_{rr}	Reverse Recovery Time	I_F=40A,	—	25	—	nS
Q_{rr}	Reverse Recovery Charge	dI/dt=100A/us	—	18.5	—	nC
Dynamic Characteristics[2]						
R_G	Gate Resistance	V_{GS}=0V, V_{DS}=0V, Frequency=1MHz	—	1.3	—	Ω
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=25V Frequency=1MHz	—	3110	—	pF
C_{oss}	Output Capacitance		—	445	—	
C_{rss}	Reverse Transfer Capacitance		—	270	—	
$t_{d(on)}$	Turn-On Delay Time	V_{DD}=37.5V,I_D=40A, V_{GS}=10V,R_G=6.8Ω	—	20.4	—	nS
t_r	Rise Time		—	63	—	
$t_{d(off)}$	Turn-Off Delay Time		—	67	—	
t_f	Fall Time		—	43	—	
Gate Charge Characteristics[2]						
Q_g	Total Gate Charge	V_{DS}=37.5V,V_{GS}=10V I_D=40A	—	76	—	nC
Q_{gs}	Gate-to-Source Charge		—	9.5	—	
Q_{gd}	Gate-to-Drain Charge		—	40	—	

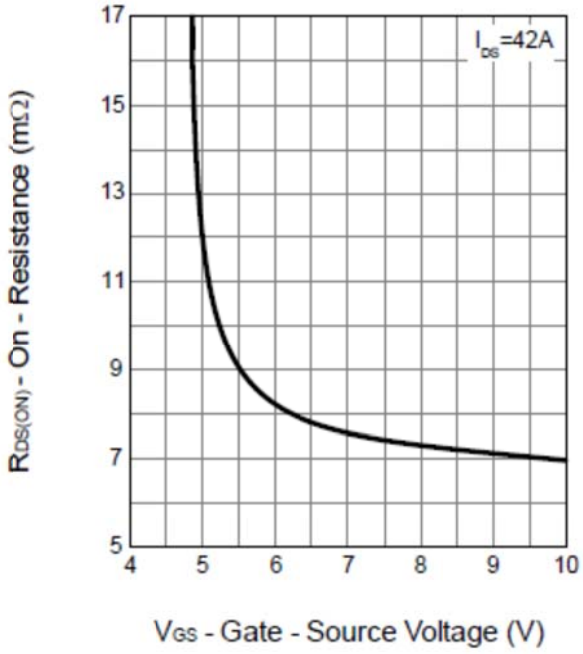
Note: 1: Pulse test; pulse width ≦ 300us, duty cycle ≦ 2%.
2: Guaranteed by design, not subject to production testing.
3: Package limitation current is 50A.Calculated continuous current based on maximum allowable junction temperature.
4: Repetitive rating, pulse width limited by max junction temperature.
5: Starting TJ = 25°C,L = 1mH,IAS = 40A.

Typical Operating Characteristics

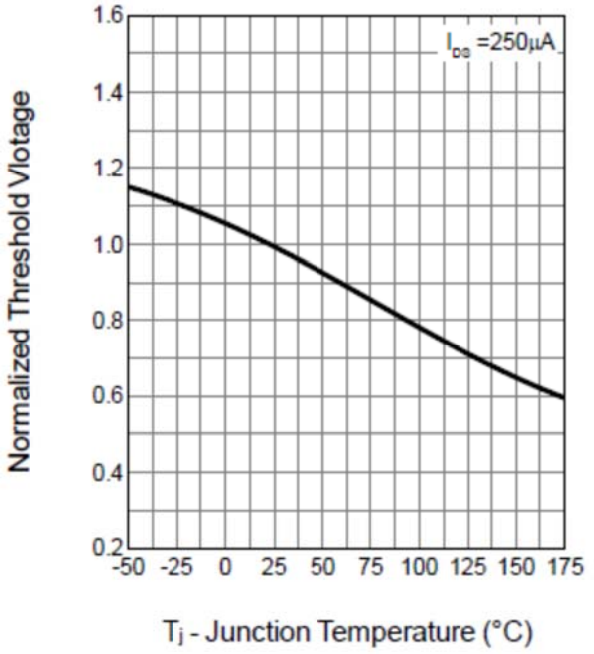




Drain-Source On Resistance

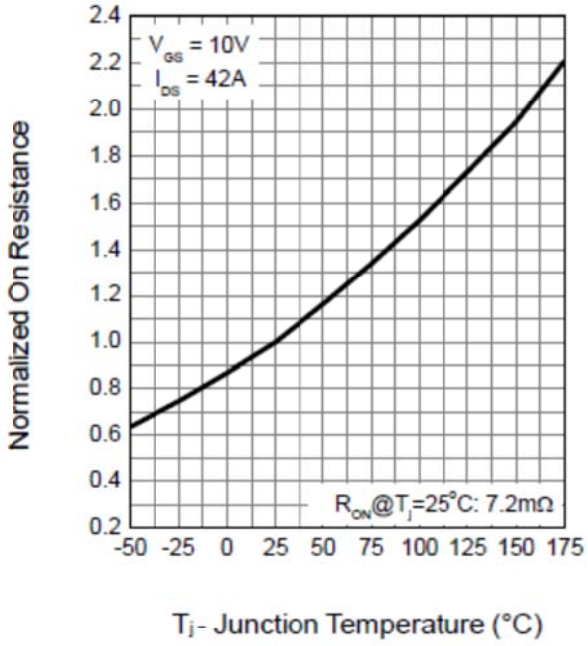


Gate Threshold Voltage

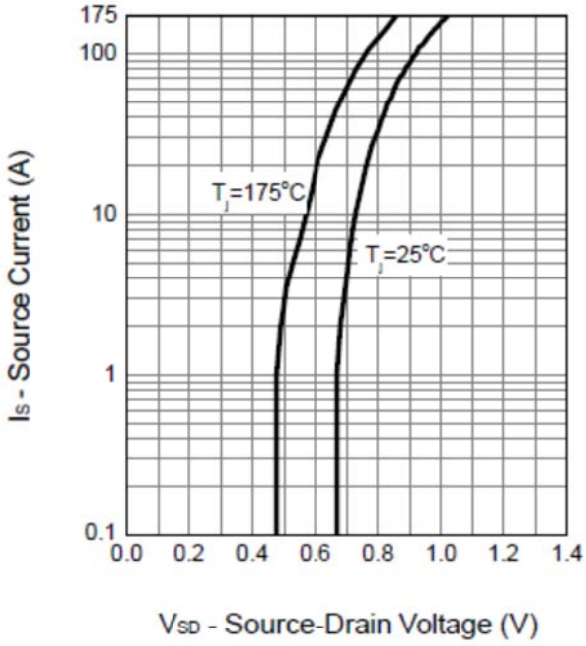


Typical Operating Characteristics

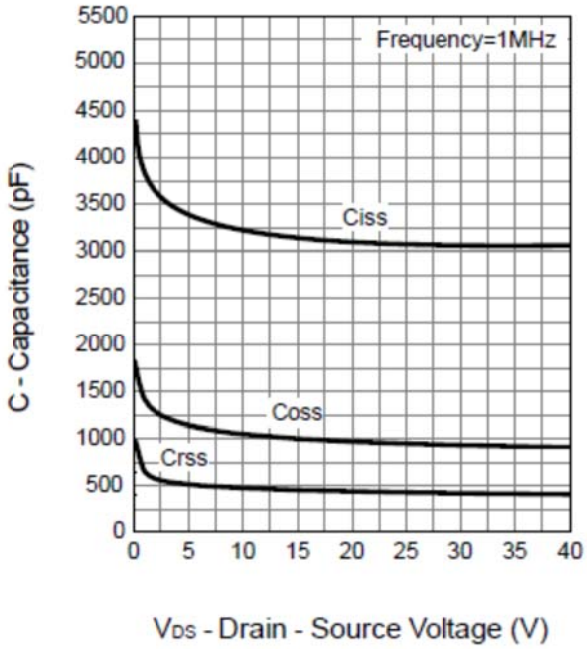
Drain-Source On Resistance



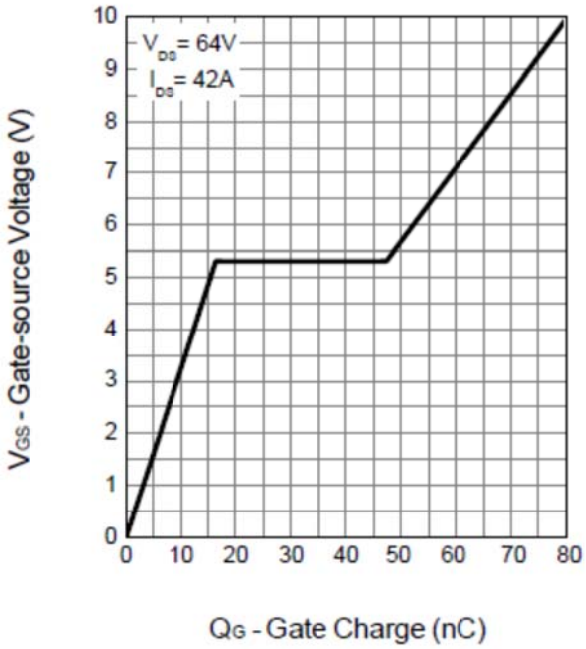
Source-Drain Diode Forward



Capacitance

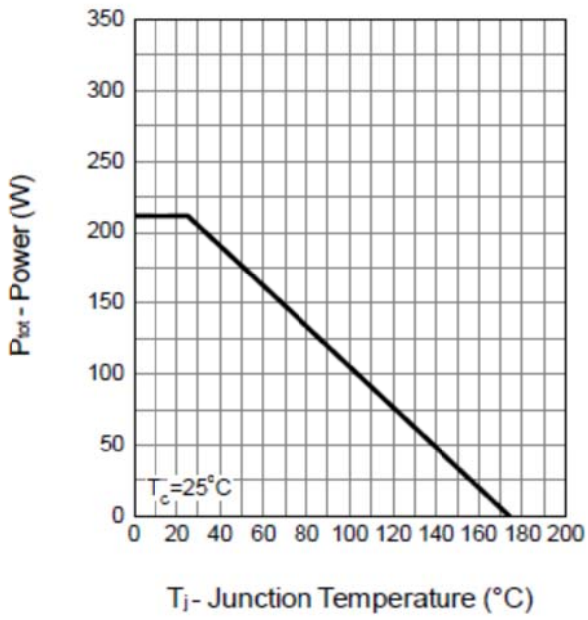


Gate Charge

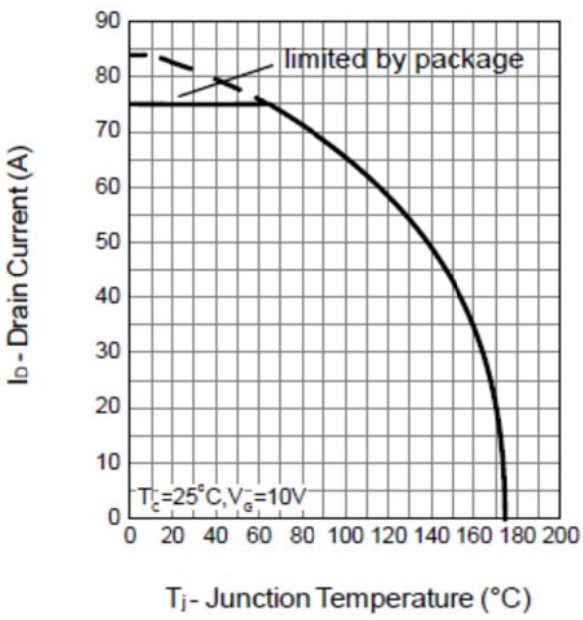


Typical Operating Characteristics

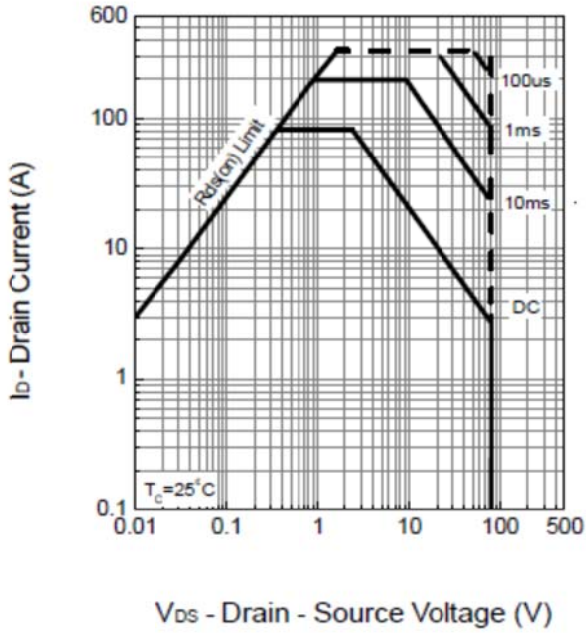
Power Dissipation



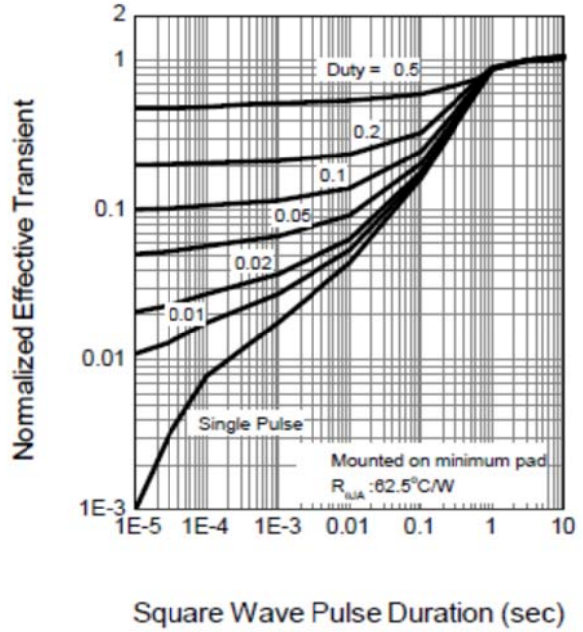
Drain Current



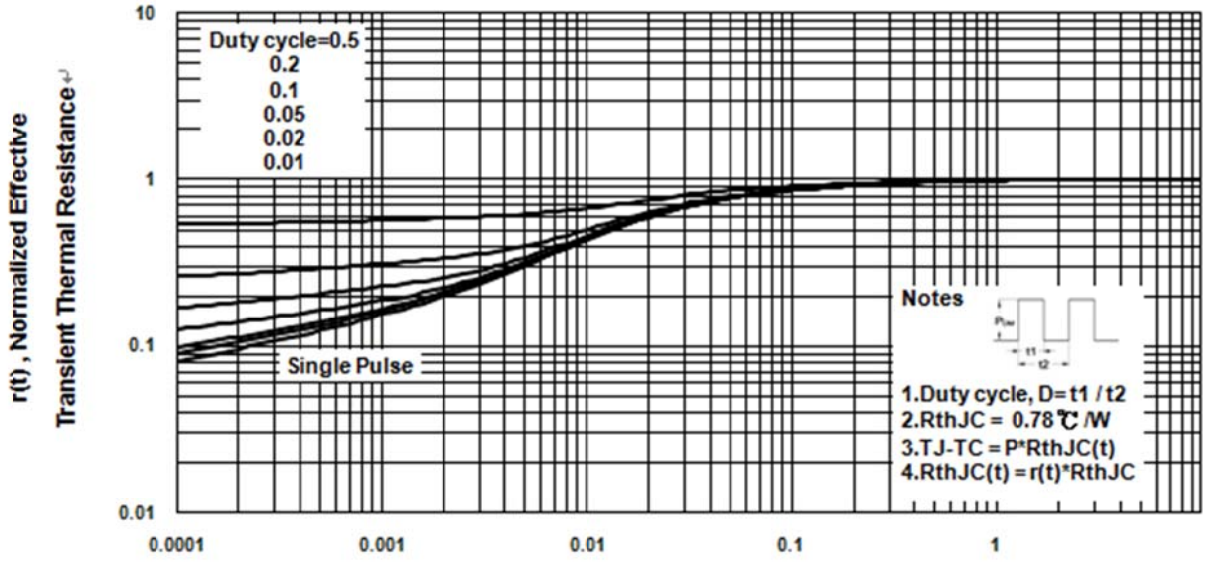
Safe Operation Area



Thermal Transient Impedance



Typical Operating Characteristics



Transient Thermal Response Curve